

Figure 2. NIM Module
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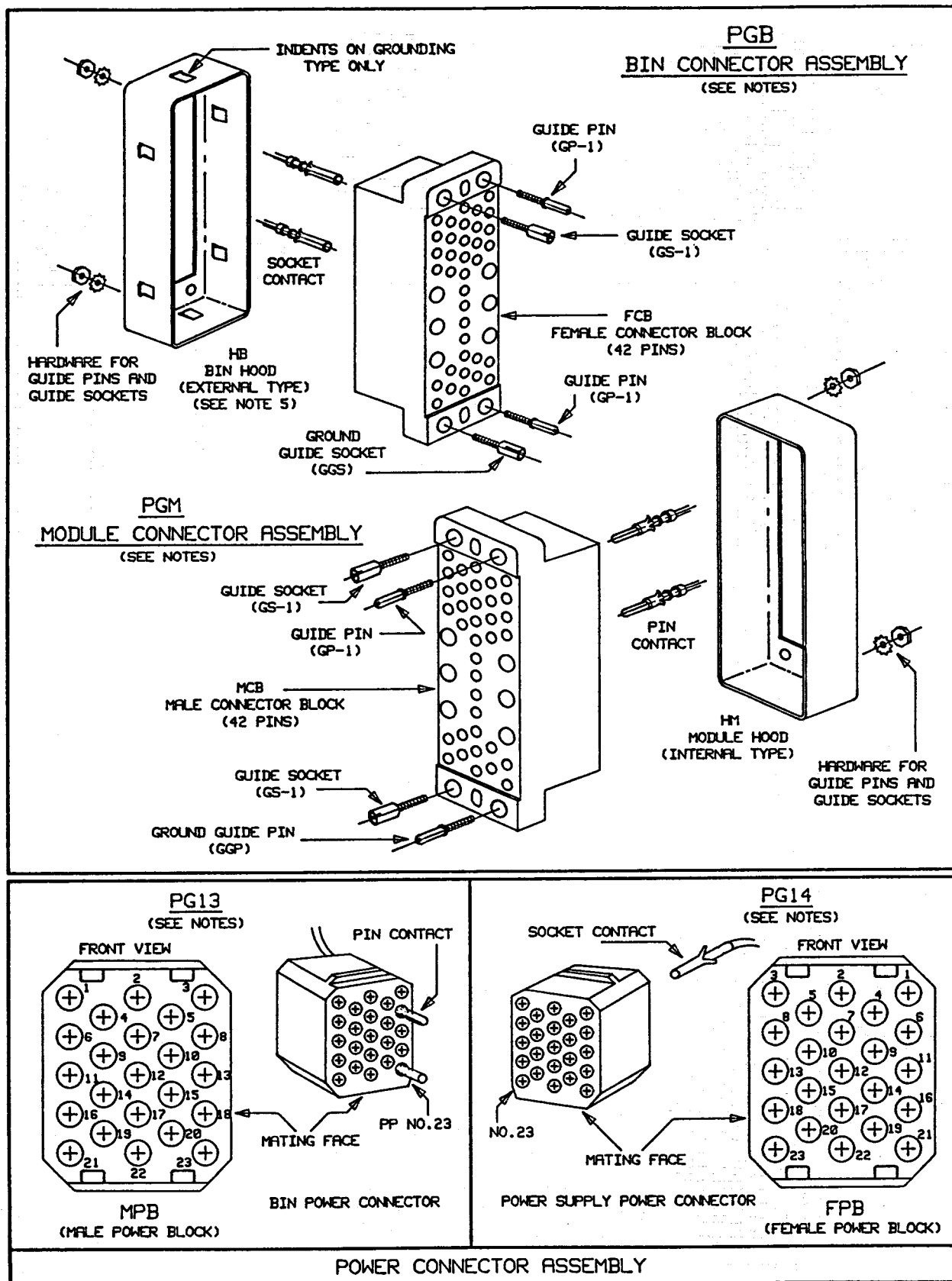


Figure 3a. Connector Assemblies

NOTES:

1. PGB AND PGM CONSIST OF THE FOLLOWING, ASSEMBLED AS INDICATED ON THIS DRAWING. ON SOME DRAWINGS PGB CONNECTOR ASSEMBLIES ARE IDENTIFIED AS PG1B THRU PG12B TO INDICATE LOCATION IN BIN AS PER NOTE 2 OF FIG.8b. A SIMILAR NOTATION IS OCCASIONALLY USED FOR PGM TO IDENTIFY MODULE POSITION IN BIN.

PGB

1 EACH FEMALE CONNECTOR BLOCK (FCB)
1 EACH GROUND GUIDE SOCKET (GGS)
1 EACH GUIDE SOCKET (GS-1)
2 EACH GUIDE PIN (GP-1)
SOCKET CONTACTS AS REQUIRED

PGM

1 EACH MALE CONNECTOR BLOCK (MCB)
1 EACH GROUND GUIDE PIN (GGP)
2 EACH GUIDE SOCKET (GS-1)
1 EACH GUIDE PIN (GP-1)
PIN CONTACTS AS REQUIRED

PGB AND PGM CONNECTOR ASSEMBLY COMPONENTS

NIM IDENTIFICATION	AMP ASSEMBLY (SEE NOTE 8)		WINCHESTER ASSEMBLY (SEE NOTE 8)	
	PART NO.	REMARKS	PART NO.	REMARKS
FCB FEMALE BLOCK FOR (PGB)	202516-3	BLUE (DAP)	111-20854	GRAY (DAP)
" (ACCEPTABLE ALTERNATE)	202516-1	BLACK (PHENOLIC)	111-20854-T43	BLACK (PHENOLIC)
MCB MALE BLOCK FOR (PGM)	204186-5	GREEN (DAP)	111-20853-1	GRAY (DAP)
" (ACCEPTABLE ALTERNATE)	204186-1	BLACK (PHENOLIC)	111-20853-1-T43	BLACK (PHENOLIC)
GP-1 GUIDE PIN	200833-2	STAINLESS STEEL	111-20855	GOLD PLATED
GS-1 GUIDE SOCKET	203964-5	STAINLESS STEEL	111-20856-1	GOLD PLATED
GGP GROUND PIN	202514-1	GOLD PLATED	111-20855	GOLD PLATED
GGS GROUND GUIDE SOCKET	202512-1	GOLD PLATED	111-20858	GOLD PLATED
HM MODULE CONNECTOR HOOD	202394-2	ZINC PLATED STEEL	111-20851-1	CADMIUM PLATED
HB BIN CONNECTOR HOOD OR	202579-5	GROUNDING ZINC P.S.		
HB BIN CONNECTOR HOOD	201390-5	NON-GNDG. ZINC P.S.	111-20852-1	NON-GNDG. CAD.PL
CONTACTS	TYPE II LONG (SEE NOTE 3)		(SEE NOTE 7)	
	TYPE III+ LONG (SEE NOTE 4)			

2. PG-13 AND PG-14 CONSIST OF THE FOLLOWING, ASSEMBLED AS INDICATED ON FIG. 3a.

PG-13

1 EACH MALE POWER BLOCK (MPB)
1 EACH POLARIZING PIN (PP)
PIN CONTACTS AS REQUIRED

PG-14

1 EACH FEMALE POWER BLOCK (FPB)
SOCKET CONTACTS AS REQUIRED

PG-13 AND PG-14 CONNECTOR ASSEMBLY COMPONENTS

NIM IDENTIFICATION	AMP ASSEMBLY (SEE NOTE 8)		WINCHESTER ASSEMBLY (SEE NOTE 8)	
	PART NO.	REMARKS	PART NO.	REMARKS
MPB MALE POWER BLOCK FOR (PG-13)	202650-2	BLUE (DAP)	111-20859	GRAY (DAP)
" (ACCEPTABLE ALTERNATE)	202650-1	BLACK (PHENOLIC)	111-20859-T43	BLACK (PHENOLIC)
FPB FEMALE POWER BLOCK FOR (PG-14)	202651-2	BLUE (DAP)	111-20860	GRAY (DAP)
" (ACCEPTABLE ALTERNATE)	202651-1	BLACK (PHENOLIC)	111-20860-T43	BLACK (PHENOLIC)
PP POLARIZING PIN FOR (PG-13)	202888-1	NAT. NYLON		
CONTACTS	TYPE II LONG (SEE NOTE 3)		(SEE NOTE 7)	
	TYPE III+ LONG (SEE NOTE 4)			

3. AMP TYPE II CONTACTS (#16, .062" DIAMETER) 202507-1 AND 202508-1 ACCOMMODATE ONE #16 OR ONE #18 OR TWO #20 OR TWO #22 AWG WIRES WITH INSULATION GRIP (TOOL NO. 90136-1). 202725-1 AND 202726-1 ACCOMMODATE TWO #18 OR ONE #14 AWG WIRES WITHOUT INSULATION GRIP (TOOL NO. 45098). 201578-1 AND 201580-1 ACCOMMODATE ONE #20 OR ONE #22 AWG WIRE WITH INSULATION GIRP (TOOL NO. 45099). THESE ARE TYPICAL CONTACTS ONLY AND OTHER CONTACTS HAVE SIMILAR CAPABILITIES. (SEE NOTE 8)
4. AMP TYPE III AND CONTACTS (#16, .062" DIAMETER) A WIDE VARIETY OF TYPE III+ CONTACTS (SUCH AS PIN 66098-1 AND SOCKET 66100-1 AND MANY OTHERS) ARE AVAILABLE. (SEE NOTE 8)
5. BIN CONNECTOR HOOD IS OPTIONAL. 0.031" (0.8MM) SPACER IS REQUIRED WHEN HOOD IS NOT USED.
6. LOW RESISTANCE CONTACTS FOR HIGH CURRENT APPLICATIONS.
AMP TYPE II (#16, .062" DIAMETER) (SEE NOTE 3 AND NOTE 8)
7. WINCHESTER CONTACTS (#16, .062" DIAMETER) (SEE NOTE 8)
(ALL CONTACTS LISTED BELOW USE WINCHESTER CRIMP TOOL #107-0970)

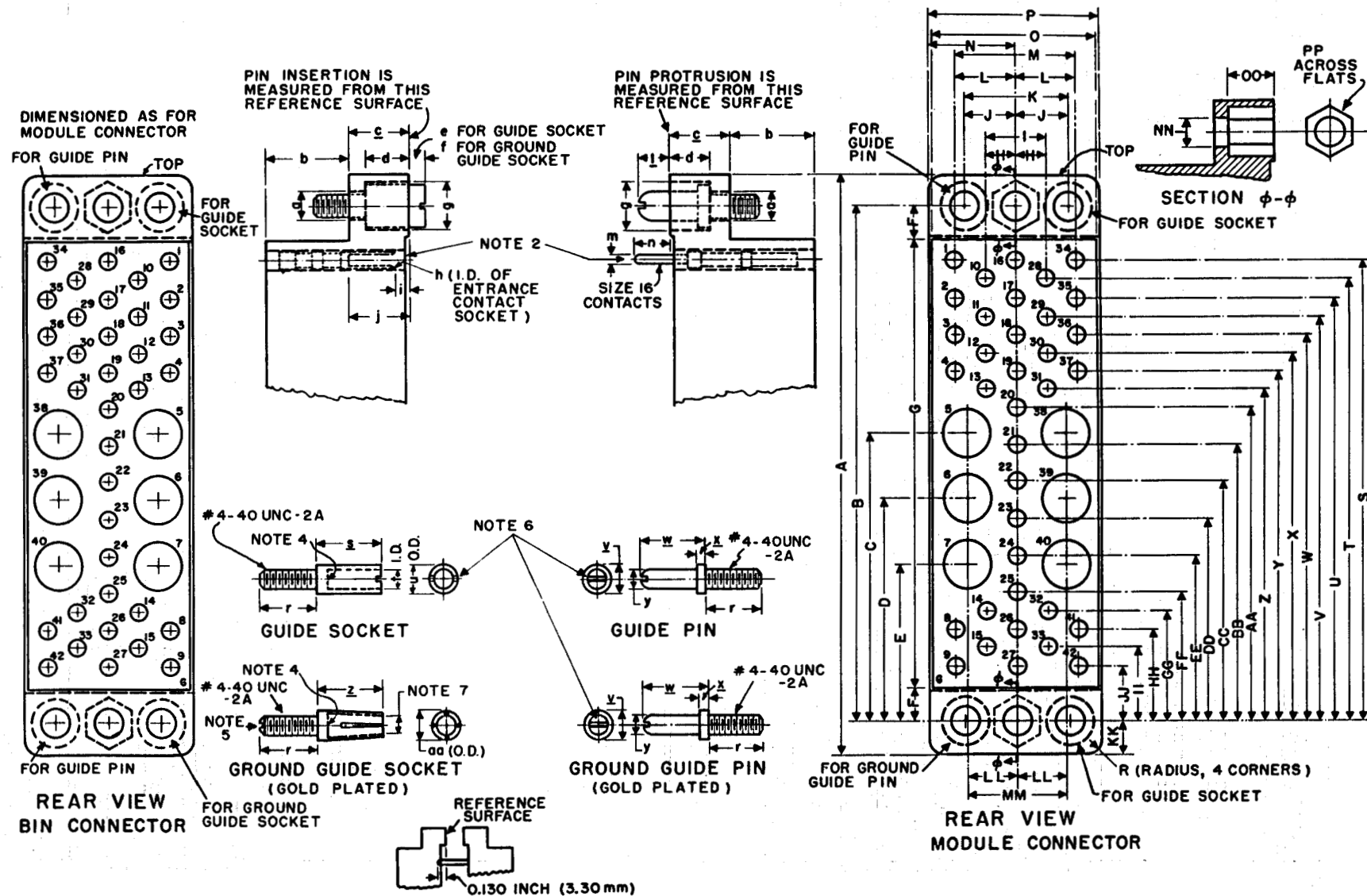
WIRES ACCOMMODATED	WINCHESTER PIN #	WINCHESTER SOCKET #	LOCATOR TO BE USED WITH CRIMP TOOL (WINCHESTER NO.)	NOTES
1-#14 OR 2-#18 OR 2-#20 AWG	100 - 7113P	-	107 - 0977 (BLUE)	WITHOUT INSULATION SUPPORT
	-	100 - 7113S	107 - 0982 (WHITE)	
1-#16 OR 1-#18 OR 1-#20 OR 2-#22 AWG	100 - 7116P	-	107 - 0977 (BLUE)	WITH INSULATION SUPPORT
	-	100 - 7116S	107 - 0982 (WHITE)	
1-#20 OR 1-#22 OR 1-#24 AWG	100 - 7120P	-	107 - 0776 (RED)	WITH INSULATION SUPPORT
	-	100 - 7120S	107 - 0985 (BLACK)	

8. THE MANUFACTURERS OF THE COMPONENTS LISTED HEREON (FIG. 3b) HAVE ADVISED THAT THESE COMPONENTS ARE IN ACCORDANCE WITH FIG. 4a AND FIG 10. DIALYL PHTHALATE (DAP) CONNECTOR BLOCKS WERE ORIGINALLY SPECIFIED, PHENOLIC BLOCKS ARE NOW ACCEPTABLE.

Figure 3b. Connector Assembly Notes

Figure 4a. Module and Bin Connector Details

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REF	INCHES		MILLIMETERS	
	MIN.	MAX.	MIN.	MAX.
A	2.573	2.613	65.35	66.37
B	2.277	2.293	57.83	58.24
C	1.265	1.275	32.13	32.39
D	0.975	0.985	24.77	25.02
E	0.685	0.695	17.40	17.65
F	0.141	—	3.58	—
G	—	1.995	—	50.67
H	0.130	0.140	3.30	3.56
I	0.265	0.275	6.73	6.99
J	0.229	0.239	5.82	6.07
K	0.463	0.473	11.76	12.01
L	0.265	0.275	6.73	6.99
M	0.535	0.545	13.59	13.84
N	0.370	0.380	9.40	9.65
O	—	0.750	—	19.05
P	—	0.760	—	19.30
R	0.062	—	1.57	—
S	2.027	2.037	51.49	51.74
T	1.946	1.956	49.43	49.68
U	1.865	1.875	47.37	47.63
V	1.784	1.794	45.31	45.57
W	1.703	1.713	43.26	43.51
X	1.622	1.632	41.20	41.45
Y	1.541	1.551	39.14	39.40
Z	1.460	1.470	37.08	37.34
AA	1.379	1.389	35.03	35.28
BB	1.217	1.227	30.91	31.17
CC	1.055	1.065	26.80	27.05
DD	0.893	0.903	22.68	22.94
EE	0.731	0.741	18.57	18.82
FF	0.569	0.579	14.45	14.71
GG	0.488	0.498	12.40	12.65
HH	0.407	0.417	10.34	10.59
II	0.326	0.336	8.28	8.53
JJ	0.245	0.255	6.22	6.48
KK	0.151	0.161	3.84	4.09
LL	0.211	0.221	5.36	5.61
MM	0.427	0.437	10.85	11.10
NN	0.115	0.125	2.92	3.18
OO	0.300	0.320	7.62	8.13
PP	0.191	0.195	4.85	4.95
a	0.115	0.125	2.92	3.18
b	—	0.570	—	14.48
c	0.368	0.382	9.35	9.70
d	0.255	0.265	6.48	6.73
e	0.190	0.215	4.83	5.46
f	0.135	0.155	3.43	3.94
g	0.213	0.223	5.41	5.66
h	0.065	—	1.65	—
i	0.010	—	0.25	—
j	0.375	—	9.53	—
l	0.165	0.195	4.19	4.95
m	0.061	0.063	1.55	1.60
n	0.250	0.310	6.35	7.87
r	0.380	0.410	9.65	10.41
s	0.455	0.470	11.56	11.94
t	0.138	0.144	3.51	3.66
u	0.198	0.208	5.03	5.28
v	0.150	0.185	3.81	4.70
w	0.430	0.450	10.92	11.43
x	0.027	0.037	0.69	0.94
y	0.123	0.131	3.12	3.33
z	0.400	0.410	10.16	10.41
aa	0.175	0.185	4.45	4.70

NOTES:

1. THE MILLIMETER DIMENSIONS ARE DERIVED FROM THE ORIGINAL INCH DIMENSIONS.
2. THE PIN-SOCKET CONTACT RESISTANCE SHALL NOT EXCEED THREE MILLIOHMS WHEN CONTACT PIN EXTENDS 0.130 INCH (3.30 mm) BEYOND THE REFERENCE SURFACE OF THE BIN CONNECTOR BLOCK NOR SHALL IT EXCEED THREE MILLIOHMS FOR ANY PROTRUSION GREATER THAN 0.130 INCH (3.30 mm) BEYOND THE REFERENCE SURFACE OF THE BIN CONNECTOR BLOCK. PIN-SOCKET CONTACT RESISTANCE SHALL BE MEASURED AT ONE AMPERE.
3. NOTE 3 DELETED.
4. DEPTH OF HOLE IN GUIDE SOCKET AND GROUND GUIDE SOCKET SHALL BE ADEQUATE TO ACCOMMODATE GUIDE PINS WITH MAXIMUM PERMISSIBLE PROTRUSION WHEN REFERENCE FACES OF BIN AND MODULE BLOCKS ARE FULLY MATED.
5. SLOT 0.031 +/-0.005 INCH (0.79 +/-0.13 mm) WIDE, 0.050 +/-0.005 INCH (1.3 +/-0.13 mm) DEEP.
6. SLOT 0.032 +/-0.005 INCH (0.82 +/-0.13 mm) WIDE, 0.060 +/-0.005 INCH (1.5 +/-0.13 mm) DEEP.
7. 0.115 +/-0.005 INCH (2.92 +/-0.13 mm) ENTRANCE I.D. MUST ACCOMMODATE GROUND GUIDE PIN AND MUST EXERT SPRING PRESSURE ON GROUND GUIDE PIN WHEN MATED.

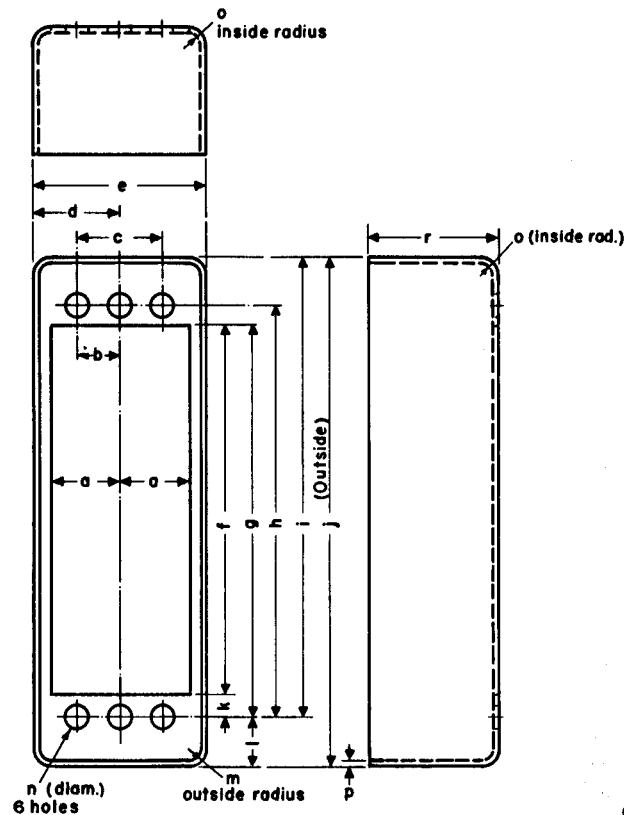
Figure 4b. Module and Bin Connector Dimensions and Notes

Figure 5. Bin and Module Connector Hoods

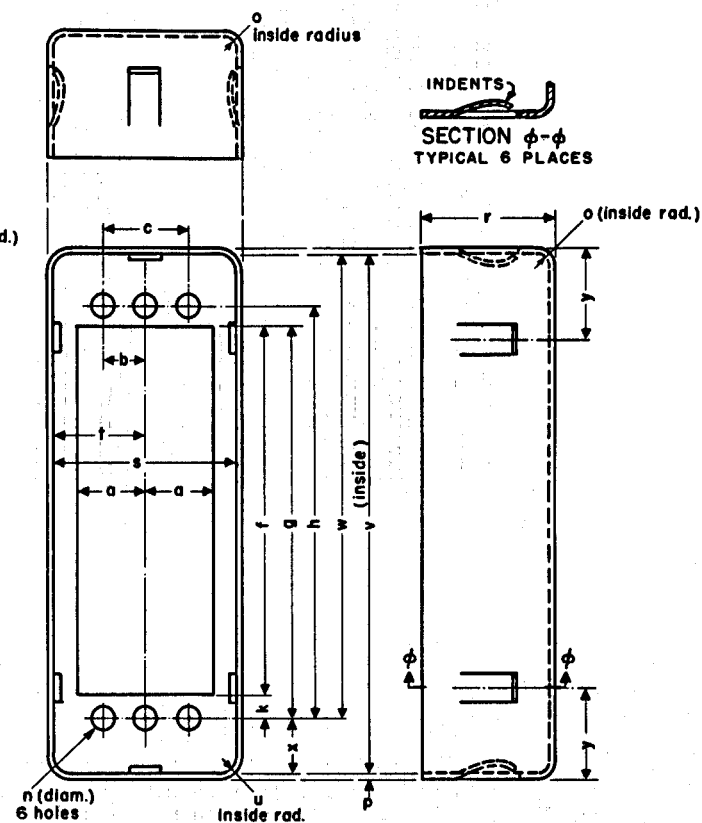
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REF	INCHES		MILLIMETERS	
	MIN.	MAX.	MIN.	MAX.
a	0.380	—	9.65	—
b	0.229	0.239	5.82	6.07
c	0.463	0.473	11.76	12.01
d	0.470	0.480	11.94	12.19
e	0.945	0.955	24.00	24.26
f	*	*	*	*
g	2.150	2.160	54.61	54.86
h	2.276	2.286	57.81	58.06
i	2.529	2.539	64.24	64.49
j	2.782	2.792	70.67	70.92
k	0.120	0.130	3.05	3.30
l	0.248	0.258	6.30	6.55
m	0.11	0.14	2.8	3.6
n	0.128	—	3.25	—
o	—	0.077	—	1.96
p	0.028	0.034	0.71	0.86
r	0.672	0.702	17.07	17.83
s	0.995	1.005	25.27	25.53
t	0.495	0.505	12.57	12.83
u	—	0.15	—	3.8
v	2.839	2.849	72.11	72.36
w	2.557	2.567	64.95	65.20
x	0.277	0.287	7.04	7.29
y	0.40	0.60	10.	15.

* f. IS REFERENCE DIMENSION 2.030 INCH (51.56 mm)



MODULE HOOD



OPTIONAL BIN HOOD (GROUNDING TYPE)
(INDENTS OMITTED ON NONE GROUNDING TYPE)

INDENTS
SECTION $\phi-\phi$
TYPICAL 6 PLACES

NOTES: -

1. THE MILLIMETER DIMENSIONS ARE DERIVED FROM THE ORIGINAL INCH DIMENSIONS.
2. INDENTS ON GROUNDING TYPE BIN HOOD SHALL EXERT PRESSURE AGAINST MODULE HOOD TO ASSURE ELECTRICAL RESISTANCE OF NOT OVER 0.001 OHM BETWEEN THE HOODS. HOOD MATERIAL SHALL BE SUCH AS TO MAINTAIN ELECTRICAL RESISTANCE OF NOT OVER 0.001 OHM. (FOR EXAMPLE CADMIUM PLATED STEEL). THE FORCE NECESSARY TO INSERT MODULE HOOD INTO GROUNDING TYPE BIN HOOD SHALL NOT EXCEED 3 POUNDS WITH VERTICAL AND HORIZONTAL MISALIGNMENTS OF UP TO 0.015 INCH (0.38 mm).

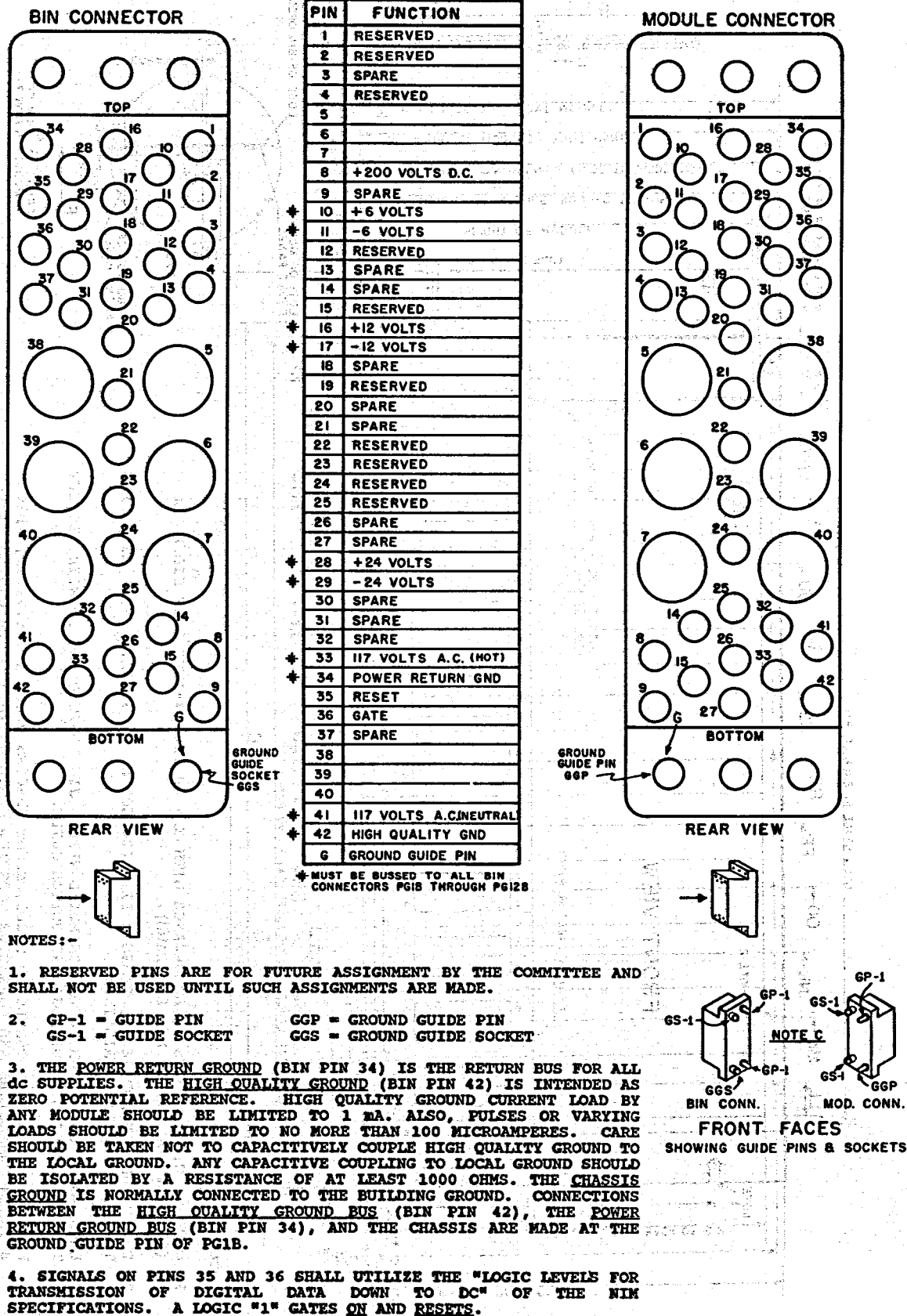


Figure 6. Bin and Module Connector Pin Assignments